

## IEEE 802.3da SPMD TF Plenary meeting March, 23 2022

Prepared by Peter Jones

Agendas, minutes, presentations, etc posted at:

<https://www.ieee802.org/3/da/index.html>

### Agenda/Admin - Chad Jones

All times in Pacific Time (PT)

07:02am: Meeting commences. The Chair reviewed the agenda deck.

07:02am: The Chair asked if there were any corrections or additions to the agenda. There being no corrections or additions, the agenda stands approved.

07:03am: The Chair asked if anyone hasn't had a chance to review the minutes for February 23, 2022 and March 9, 2022. None responded. The Chair asked if there were any change to be made to these minutes. None responded. The February 23, 2022 and March 9, 2022 minutes were approved by unanimous consent.

07:03am: Agenda deck continues. From the "INSTRUCTIONS FOR THE WG CHAIR" slide in [https://www.ieee802.org/3/WG\\_tools/templates/Task\\_Force\\_agenda\\_V3p9.pptx](https://www.ieee802.org/3/WG_tools/templates/Task_Force_agenda_V3p9.pptx):

- Instruct the WG Secretary to record in the minutes of the relevant WG meeting:
  - That the foregoing information was provided and that slides 1 through 4 (and this slide 0, if applicable) were shown;
  - That the chair or designee provided an opportunity for participants to identify patent claim(s)/patent application claim(s) and/or the holder of patent claim(s)/patent application claim(s) of which the participant is personally aware and that may be essential for the use of that standard
  - Any responses that were given, specifically the patent claim(s)/patent application claim(s) and/or the holder of the patent claim(s)/patent application claim(s) that were identified (if any) and by whom.

07:08am: Call for patents was made, no one responded.

07:12am: Opening agenda slides complete. The meeting moves on to presentations.

### Presentations/Discussion.

07:12am: PLCA Corner-case Fixes,

Piergiorgio Beruto, CanovaTech

07:25am: Start of Q&A.

07:26am: Motions

Move to adopt changes found in

[https://www.ieee802.org/3/da/public/022322/beruto\\_3da\\_01\\_230222\\_plca\\_fixes.pdf](https://www.ieee802.org/3/da/public/022322/beruto_3da_01_230222_plca_fixes.pdf) on pages 7, 11, and 14 for incorporation into the next draft.

M: Piergiorgio Beruto

S: Tim Baggett

Motion passes by unanimous consent

room count - 33 in 'room', 18 802.3 voters

07:31am: presentation done.

07:31am: Next Steps and Closing remarks begins

Long discussion about mixing segment specifications/requirements and heterogeneous/homogeneous cabling.

08:31am: Next Steps and Closing remarks finish

Next meeting: April 6, 2022, 7:00am PT.

## Meeting closed - 08:32am

### Attendees (from Webex + chat)

Name	Employer	Affiliation	Attended 03/23
Bob Voss	Panduit Corp.	Panduit Corp.	y
Chad Jones	Cisco Systems, Inc.	Cisco Systems, Inc.	y
Chris Diminico	MC Communications	Panduit	y
Clark Carty	Cisco Systems, Inc.	Cisco Systems, Inc.	y
Dave Hess	Cord Data	Cord Data	y
David D. Brandt	Rockwell Automation	Rockwell Automation	y
Denis Beaudoin	Texas Instruments	Texas Instruments	y
Geoff Thompson	GraCaSI S.A.	Independent	y
George Zimmerman	CME Consulting	ADI, APL Group, Cisco Systems, CommScope, Marvell, SenTekSe	y
Harry Aller	Innovative Lighting	Innovative Lighting	y
Heath Stewart	Analog Devices Inc.	Analog Devices Inc.	y
Jason Potterf	Cisco Systems, Inc.	Cisco Systems, Inc.	y
Jerome BRENGUIER	Schneider Electric	Schneider Electric	y
Joe Aronson	Texas Instruments	Texas Instruments	y
Ken Schneider	Telebyte Inc	Telebyte Inc	y
Kirsten Matheus	BMW Group	BMW Group	y
Kiyoshi Saito	Furukawa Electric	Furukawa Electric	y
Olindo Savi	Hubbell	Hubbell	y

Peter Fischer	BKS Kabel-Service AG	BKS Kabel-Service AG	y
Peter Jones	Cisco Systems, Inc.	Cisco Systems, Inc.	y
Piergiorgio Beruto	Canova Tech	Canova Tech	y
Sami Akin	Volkswagen AG	Volkswagen AG	y
Scott Griffiths	Rockwell Automation	Rockwell Automation	y
Steffen Graber	Pepperl+Fuchs	Pepperl+Fuchs	y
Stephan Schreiner	Rosenberger	Rosenberger	y
Talal Alhammami	CARIAD	CARIAD	y
Thorrsten Hoffleit	Renesas	Renesas	y
Tim Baggett	Microchip Technology, Inc.	Microchip Technology, Inc.	y
Tong Mu	Huawei	Huawei	y
Wayne Larsen	CommScope	CommScope	y
Wensheng Sun	Marvell	Marvell	y
Wojciech Koczwar	Rockwell Automation	Rockwell Automation	y
Woojung Huh	Microchip	Microchip	y
Yoshihiro Niihara	Fujikura Ltd.	Fujikura Ltd.	y
Yusuke Yano	NITech	NITech	y
Attendees			35